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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	1805
Number of Logic Elements/Cells	42959
Total RAM Bits	3517440
Number of I/O	156
Number of Gates	-
Voltage - Supply	0.87V ~ 0.93V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	358-LFBGA, FCBGA
Supplier Device Package	358-UBGA, FCBGA (17x17)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/ep2agx45cu17c4">https://www.e-xfl.com/product-detail/intel/ep2agx45cu17c4</a>

**Table 1–5. Recommended Operating Conditions for Arria II GX Devices (*Note 1*) (Part 2 of 2)**

<b>Symbol</b>	<b>Description</b>	<b>Condition</b>	<b>Minimum</b>	<b>Typical</b>	<b>Maximum</b>	<b>Unit</b>
$t_{RAMP}$	Power Supply Ramp time	Normal POR	0.05	—	100	ms
		Fast POR	0.05	—	4	ms

**Notes to Table 1–5:**

- (1) For more information about supply pin connections, refer to the *Arria II Device Family Pin Connection Guidelines*.
- (2) Altera recommends a 3.0-V nominal battery voltage when connecting  $V_{CCBAT}$  to a battery for volatile key backup. If you do not use the volatile security key, you may connect the  $V_{CCBAT}$  to either GND or a 3.0-V power supply.
- (3)  $V_{CCPD}$  must be 2.5-V for I/O banks with 2.5-V and lower  $V_{CCIO}$ , 3.0-V for 3.0-V  $V_{CCIO}$ , and 3.3-V for 3.3-V  $V_{CCIO}$ .
- (4)  $V_{CCIO}$  for 3C and 8C I/O banks where the configuration pins reside only supports 3.3-, 3.0-, 2.5-, or 1.8-V voltage levels.

Table 1–6 lists the recommended operating conditions for Arria II GZ devices.

**Table 1–6. Recommended Operating Conditions for Arria II GZ Devices (*Note 6*) (Part 1 of 2)**

<b>Symbol</b>	<b>Description</b>	<b>Condition</b>	<b>Minimum</b>	<b>Typical</b>	<b>Maximum</b>	<b>Unit</b>
$V_{CC}$	Core voltage and periphery circuitry power supply	—	0.87	0.90	0.93	V
$V_{CCCB}$	Supplies power for the configuration RAM bits	—	1.45	1.50	1.55	V
$V_{CCAUX}$	Auxiliary supply	—	2.375	2.5	2.625	V
$V_{CCPD}$ (2)	I/O pre-driver (3.0 V) power supply	—	2.85	3.0	3.15	V
	I/O pre-driver (2.5 V) power supply	—	2.375	2.5	2.625	V
$V_{CCIO}$	I/O buffers (3.0 V) power supply	—	2.85	3.0	3.15	V
	I/O buffers (2.5 V) power supply	—	2.375	2.5	2.625	V
	I/O buffers (1.8 V) power supply	—	1.71	1.8	1.89	V
	I/O buffers (1.5 V) power supply	—	1.425	1.5	1.575	V
	I/O buffers (1.2 V) power supply	—	1.14	1.2	1.26	V
$V_{CCPGM}$	Configuration pins (3.0 V) power supply	—	2.85	3.0	3.15	V
	Configuration pins (2.5 V) power supply	—	2.375	2.5	2.625	V
	Configuration pins (1.8 V) power supply	—	1.71	1.8	1.89	V
$V_{CCA\_PLL}$	PLL analog voltage regulator power supply	—	2.375	2.5	2.625	V
$V_{CCD\_PLL}$	PLL digital voltage regulator power supply	—	0.87	0.90	0.93	V
$V_{CC\_CLKIN}$	Differential clock input power supply	—	2.375	2.5	2.625	V
$V_{CCBAT}$ (1)	Battery back-up power supply (For design security volatile key register)	—	1.2	—	3.3	V
	DC input voltage	—	-0.5	—	3.6	V
$V_0$	Output voltage	—	0	—	$V_{CCIO}$	V
$V_{CCA\_L}$	Transceiver high voltage power (left side)	—	2.85/2.375	3.0/2.5 (4)	3.15/2.625	V
$V_{CCA\_R}$	Transceiver high voltage power (right side)	—				
$V_{CCHIP\_L}$	Transceiver HIP digital power (left side)	—	0.87	0.9	0.93	V
$V_{CCR\_L}$	Receiver power (left side)	—	1.05	1.1	1.15	V
$V_{CCR\_R}$	Receiver power (right side)	—	1.05	1.1	1.15	V
$V_{CCT\_L}$	Transmitter power (left side)	—	1.05	1.1	1.15	V
$V_{CCT\_R}$	Transmitter power (right side)	—	1.05	1.1	1.15	V

Table 1–19 lists the weak pull-up resistor values for Arria II GZ devices.

**Table 1–19. Internal Weak Pull-Up Resistor for Arria II GZ Devices (Note 1), (2)**

Symbol	Description	Conditions	Min	Typ	Max	Unit
$R_{PU}$	Value of the I/O pin pull-up resistor before and during configuration, as well as user mode if the programmable pull-up resistor option is enabled.	$V_{CCIO} = 3.0 \text{ V} \pm 5\% \text{ (3)}$	—	25	—	$\text{k}\Omega$
		$V_{CCIO} = 2.5 \text{ V} \pm 5\% \text{ (3)}$	—	25	—	$\text{k}\Omega$
		$V_{CCIO} = 1.8 \text{ V} \pm 5\% \text{ (3)}$	—	25	—	$\text{k}\Omega$
		$V_{CCIO} = 1.5 \text{ V} \pm 5\% \text{ (3)}$	—	25	—	$\text{k}\Omega$
		$V_{CCIO} = 1.2 \text{ V} \pm 5\% \text{ (3)}$	—	25	—	$\text{k}\Omega$

**Notes to Table 1–19:**

- (1) All I/O pins have an option to enable weak pull-up except configuration, test, and JTAG pins.
- (2) The internal weak pull-down feature is only available for the JTAG TCK pin. The typical value for this internal weak pull-down resistor is approximately 25  $\text{k}\Omega$ .
- (3) Pin pull-up resistance values may be lower if an external source drives the pin higher than  $V_{CCIO}$ .

### Hot Socketing

Table 1–20 lists the hot-socketing specification for Arria II GX and GZ devices.

**Table 1–20. Hot Socketing Specifications for Arria II Devices**

Symbol	Description	Maximum
$I_{IOPIN(DC)}$	DC current per I/O pin	300 $\mu\text{A}$
$I_{IOPIN(AC)}$	AC current per I/O pin	8 mA (1)
$I_{XCVRTX(DC)}$	DC current per transceiver TX pin	100 mA
$I_{XCVRRX(DC)}$	DC current per transceiver RX pin	50 mA

**Note to Table 1–20:**

- (1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns,  $|I_{IOPIN}| = C \frac{dv}{dt}$ , in which “C” is I/O pin capacitance and “dv/dt” is slew rate.

### Schmitt Trigger Input

The Arria II GX device supports Schmitt trigger input on the TDI, TMS, TCK, nSTATUS, nCONFIG, nCE, CONF\_DONE, and DCLK pins. A Schmitt trigger feature introduces hysteresis to the input signal for improved noise immunity, especially for signals with slow edge rates.

Table 1–21 lists the hysteresis specifications across the supported  $V_{CCIO}$  range for Schmitt trigger inputs in Arria II GX devices.

**Table 1–21. Schmitt Trigger Input Hysteresis Specifications for Arria II GX Devices**

Symbol	Description	Condition (V)	Minimum	Unit
$V_{Schmitt}$	Hysteresis for Schmitt trigger input	$V_{CCIO} = 3.3$	220	mV
		$V_{CCIO} = 2.5$	180	mV
		$V_{CCIO} = 1.8$	110	mV
		$V_{CCIO} = 1.5$	70	mV

**Table 1–27. Single-Ended SSTL and HSTL I/O Standards Signal Specifications for Arria II GZ Devices (Part 2 of 2)**

I/O Standard	V <sub>IL(DC)</sub> (V)		V <sub>IH(DC)</sub> (V)		V <sub>IL(AC)</sub> (V)	V <sub>IH(AC)</sub> (V)	V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)
	Min	Max	Min	Max	Max	Min	Max	Min		
SSTL-15 Class II	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.175	V <sub>REF</sub> + 0.175	0.2 × V <sub>CCIO</sub>	0.8 × V <sub>CCIO</sub>	16	-16
HSTL-18 Class I	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	8	-8
HSTL-18 Class II	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	16	-16
HSTL-15 Class I	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	8	-8
HSTL-15 Class II	—	V <sub>REF</sub> - 0.1	V <sub>REF</sub> + 0.1	—	V <sub>REF</sub> - 0.2	V <sub>REF</sub> + 0.2	0.4	V <sub>CCIO</sub> - 0.4	16	-16
HSTL-12 Class I	-0.15	V <sub>REF</sub> - 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	8	-8
HSTL-12 Class II	-0.15	V <sub>REF</sub> - 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> - 0.15	V <sub>REF</sub> + 0.15	0.25 × V <sub>CCIO</sub>	0.75 × V <sub>CCIO</sub>	16	-16

Table 1–28 lists the differential SSTL I/O standards for Arria II GX devices.

**Table 1–28. Differential SSTL I/O Standards for Arria II GX Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>SWING(DC)</sub> (V)		V <sub>X(AC)</sub> (V)			V <sub>SWING(AC)</sub> (V)		V <sub>OX(AC)</sub> (V)		
	Min	Typ	Max	Min	Max	Min	Typ	Max	Min	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.36	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.2	—	V <sub>CCIO</sub> /2 + 0.2	0.7	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.15	—	V <sub>CCIO</sub> /2 + 0.15
SSTL-18 Class I, II	1.71	1.8	1.89	0.25	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.175	—	V <sub>CCIO</sub> /2 + 0.175	0.5	V <sub>CCIO</sub>	V <sub>CCIO</sub> /2 - 0.125	—	V <sub>CCIO</sub> /2 + 0.125
SSTL-15 Class I, II	1.425	1.5	1.575	0.2	—	—	V <sub>CCIO</sub> /2	—	0.35	—	—	V <sub>CCIO</sub> /2	—

Table 1–29 lists the differential SSTL I/O standards for Arria II GZ devices

**Table 1–29. Differential SSTL I/O Standards for Arria II GZ Devices**

I/O Standard	V <sub>CCIO</sub> (V)			V <sub>SWING(DC)</sub> (V)		V <sub>X(AC)</sub> (V)			V <sub>SWING(AC)</sub> (V)		V <sub>OX(AC)</sub> (V)		
	Min	Typ	Max	Min	Max	Min	Typ	Max	Min	Max	Min	Typ	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.3	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.2	—	V <sub>CCIO</sub> /2 + 0.2	0.62	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.15	—	V <sub>CCIO</sub> /2 + 0.15
SSTL-18 Class I, II	1.71	1.8	1.89	0.25	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.175	—	V <sub>CCIO</sub> /2 + 0.175	0.5	V <sub>CCIO</sub> + 0.6	V <sub>CCIO</sub> /2 - 0.125	—	V <sub>CCIO</sub> /2 + 0.125
SSTL-15 Class I, II	1.425	1.5	1.575	0.2	—	—	V <sub>CCIO</sub> /2	—	0.35	—	—	V <sub>CCIO</sub> /2	—

Table 1–34. Transceiver Specifications for Arria II GX Devices **(Note 1)** (Part 2 of 7)

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max										
Spread-spectrum downspread	PCIe	—	0 to -0.5%	—	—									
On-chip termination resistors	—	—	100	—	—	100	—	—	100	—	—	100	—	Ω
V <sub>ICM</sub> (AC coupled)	—	1100 ± 5%			1100 ± 5%			1100 ± 5%			1100 ± 5%			mV
V <sub>ICM</sub> (DC coupled)	HCSL I/O standard for PCIe reference clock	250	—	550	250	—	550	250	—	550	250	—	550	mV
Transmitter REFCLK Phase Noise	10 Hz	—	—	-50	—	—	-50	—	—	-50	—	—	-50	dBc/Hz
	100 Hz	—	—	-80	—	—	-80	—	—	-80	—	—	-80	dBc/Hz
	1 KHz	—	—	-110	—	—	-110	—	—	-110	—	—	-110	dBc/Hz
	10 KHz	—	—	-120	—	—	-120	—	—	-120	—	—	-120	dBc/Hz
	100 KHz	—	—	-120	—	—	-120	—	—	-120	—	—	-120	dBc/Hz
	≥ 1 MHz	—	—	-130	—	—	-130	—	—	-130	—	—	-130	dBc/Hz
Transmitter REFCLK Phase Jitter (rms) for 100 MHz REFCLK <b>(3)</b>	10 KHz to 20 MHz	—	—	3	—	—	3	—	—	3	—	—	3	ps
R <sub>ref</sub>	—	—	2000 ± 1%	—	—	2000 ± 1%	—	—	2000 ± 1%	—	—	2000 ± 1%	—	Ω
<b>Transceiver Clocks</b>														
Calibration block clock frequency (cal_blk_clk)	—	10	—	125	10	—	125	10	—	125	10	—	125	MHz

Table 1–34. Transceiver Specifications for Arria II GX Devices **(Note 1)** (Part 3 of 7)

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max										
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	—	—	125	—	—	125	—	MHz
reconfig_clk clock frequency	Dynamic reconfig. clock frequency	2.5/ 37.5 <i>(4)</i>	—	50	MHz									
Delta time between reconfig_clks <i>(5)</i>	—	—	—	2	—	—	2	—	—	2	—	—	2	ms
Transceiver block minimum power-down pulse width	—	—	1	—	—	1	—	—	1	—	—	1	—	μs
<b>Receiver</b>														
Supported I/O Standards	1.4-V PCML, 1.5-V PCML, 2.5-V PCML, 2.5-V PCML, LVPECL, and LVDS													
Data rate <i>(13)</i>	—	600	—	6375	600	—	3750	600	—	3750	600	—	3125	Mbps
Absolute V <sub>MAX</sub> for a receiver pin <i>(6)</i>	—	—	—	1.5	—	—	1.5	—	—	1.5	—	—	1.5	V
Absolute V <sub>MIN</sub> for a receiver pin	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p)	V <sub>ICM</sub> = 0.82 V setting	—	—	2.7	—	—	2.7	—	—	2.7	—	—	2.7	V
	V <sub>ICM</sub> = 1.1 V setting <i>(7)</i>	—	—	1.6	—	—	1.6	—	—	1.6	—	—	1.6	V

**Table 1–34. Transceiver Specifications for Arria II GX Devices (Note 1) (Part 4 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Minimum peak-to-peak differential input voltage $V_{ID}$ (diff p-p)	—	100	—	—	100	—	—	100	—	—	100	—	—	mV
$V_{ICM}$	$V_{ICM} = 0.82\text{ V}$ setting	—	820	—	—	820	—	—	820	—	—	820	—	mV
	$V_{ICM} = 1.1\text{ V}$ setting (7)	—	1100	—	—	1100	—	—	1100	—	—	1100	—	mV
Differential on-chip termination resistors	100- $\Omega$ setting	—	100	—	—	100	—	—	100	—	—	100	—	$\Omega$
Return loss differential mode	PCIe	50 MHz to 1.25 GHz: -10dB												
	XAUI	100 MHz to 2.5 GHz: -10dB												
Return loss common mode	PCIe	50 MHz to 1.25 GHz: -6dB												
	XAUI	100 MHz to 2.5 GHz: -6dB												
Programmable PPM detector (8)	—	$\pm 62.5, 100, 125, 200,$ $250, 300, 500, 1000$												ppm
Run length	—	—	80	—	—	80	—	—	80	—	—	80	—	UI
Programmable equalization	—	—	—	7	—	—	7	—	—	7	—	—	7	dB
Signal detect/loss threshold	PCIe Mode	65	—	175	65	—	175	65	—	175	65	—	175	mV
CDR LTR time (9)	—	—	—	75	—	—	75	—	—	75	—	—	75	$\mu\text{s}$
CDR minimum T1b (10)	—	15	—	—	15	—	—	15	—	—	15	—	—	$\mu\text{s}$

Table 1-35 lists the transceiver specifications for Arria II GZ devices.

**Table 1-35. Transceiver Specifications for Arria II GZ Devices (Part 1 of 5)**

Symbol/ Description	Conditions	-C3 and -I3 (1)			-C4 and -I4			Unit	
		Min	Typ	Max	Min	Typ	Max		
<b>Reference Clock</b>									
Supported I/O Standards	1.2-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL								
Input frequency from REFCLK input pins	—	50	—	697	50	—	637.5	MHz	
Phase frequency detector (CMU PLL and receiver CDR)	—	50	—	325	50	—	325	MHz	
Absolute $V_{MAX}$ for a REFCLK pin	—	—	—	1.6	—	—	1.6	V	
Operational $V_{MAX}$ for a REFCLK pin	—	—	—	1.5	—	—	1.5	V	
Absolute $V_{MIN}$ for a REFCLK pin	—	-0.4	—	—	-0.4	—	—	V	
Rise/fall time (2)	—	—	—	0.2	—	—	0.2	UI	
Duty cycle	—	45	—	55	45	—	55	%	
Peak-to-peak differential input voltage	—	200	—	1600	200	—	1600	mV	
Spread-spectrum modulating clock frequency	PCIe	30	—	33	30	—	33	kHz	
Spread-spectrum downspread	PCIe	—	0 to -0.5%	—	—	0 to -0.5%	—	—	
On-chip termination resistors	—	—	100	—	—	100	—	$\Omega$	
$V_{ICM}$ (AC coupled)	—	$1100 \pm 10\%$			$1100 \pm 10\%$			mV	
$V_{ICM}$ (DC coupled)	HCSL I/O standard for PCIe reference clock	250	—	550	250	—	550	mV	
Transmitter REFCLK Phase Noise	10 Hz	—	—	-50	—	—	-50	dBc/Hz	
	100 Hz	—	—	-80	—	—	-80	dBc/Hz	
	1 KHz	—	—	-110	—	—	-110	dBc/Hz	
	10 KHz	—	—	-120	—	—	-120	dBc/Hz	
	100 KHz	—	—	-120	—	—	-120	dBc/Hz	
	$\geq 1$ MHz	—	—	-130	—	—	-130	dBc/Hz	
Transmitter REFCLK Phase Jitter (rms) for 100 MHz REFCLK (3)	10 KHz to 20 MHz	—	—	3	—	—	3	ps	
$R_{REF}$	—	—	$2000 \pm 1\%$	—	—	$2000 \pm 1\%$	—	$\Omega$	

**Table 1–35. Transceiver Specifications for Arria II GZ Devices (Part 2 of 5)**

Symbol/ Description	Conditions	–C3 and –I3 (1)			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
<b>Transceiver Clocks</b>								
Calibration block clock frequency (cal_blk_clk)	—	10	—	125	10	—	125	MHz
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	—	MHz
reconfig_clk clock frequency	Dynamic reconfiguration clock frequency	2.5/37.5 (4)	—	50	2.5/37.5 (4)	—	50	MHz
Delta time between reconfig_clks (5)	—	—	—	2	—	—	2	ms
Transceiver block minimum power-down (gxb_powerdown) pulse width	—	1	—	—	1	—	—	μs
<b>Receiver</b>								
Supported I/O Standards	1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS							
Data rate (16)	—	600	—	6375	600	—	3750	Mbps
Absolute V <sub>MAX</sub> for a receiver pin (6)	—	—	—	1.6	—	—	1.6	V
Operational V <sub>MAX</sub> for a receiver pin	—	—	—	1.5	—	—	1.5	V
Absolute V <sub>MIN</sub> for a receiver pin	—	-0.4	—	—	-0.4	—	—	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) before device configuration	—	—	—	1.6	—	—	1.6	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) after device configuration	V <sub>ICM</sub> = 0.82 V setting	—	—	2.7	—	—	2.7	V
	V <sub>ICM</sub> = 1.1 V setting (7)	—	—	1.6	—	—	1.6	V
Minimum differential eye opening at receiver serial input pins (8)	Data Rate = 600 Mbps to 5 Gbps Equalization = 0 DC gain = 0 dB	100	—	—	165	—	—	mV
	Data Rate > 5 Gbps Equalization = 0 DC gain = 0 dB	165	—	—	165	—	—	mV
V <sub>ICM</sub>	V <sub>ICM</sub> = 0.82 V setting	820 ± 10%			820 ± 10%			mV
	V <sub>ICM</sub> = 1.1 V setting (7)	1100 ± 10%			1100 ± 10%			mV

**Table 1–35. Transceiver Specifications for Arria II GZ Devices (Part 3 of 5)**

Symbol/ Description	Conditions	–C3 and –I3 (1)			–C4 and –I4			Unit				
		Min	Typ	Max	Min	Typ	Max					
Receiver DC Coupling Support	—	For more information about receiver DC coupling support, refer to the “DC-Coupled Links” section in the <i>Transceiver Architecture for Arria II Devices</i> chapter.						—				
Differential on-chip termination resistors	85- $\Omega$ setting	85 $\pm$ 20%		85 $\pm$ 20%		$\Omega$		$\Omega$				
	100- $\Omega$ setting	100 $\pm$ 20%		100 $\pm$ 20%		$\Omega$		$\Omega$				
	120- $\Omega$ setting	120 $\pm$ 20%		120 $\pm$ 20%		$\Omega$		$\Omega$				
	150- $\Omega$ setting	150 $\pm$ 20%		150 $\pm$ 20%		$\Omega$		$\Omega$				
Differential and common mode return loss	PCIe (Gen 1 and Gen 2), XAUI, HiGig+, CEI SR/LR, SRIO SR/LR, CPRI LV/HV, OBSAI, SATA	Compliant						—				
Programmable PPM detector (9)	—	$\pm$ 62.5, 100, 125, 200, 250, 300, 500, 1,000						ppm				
Run length	—	—	—	200	—	—	200	UI				
Programmable equalization	—	—	—	16	—	—	16	dB				
t <sub>LTR</sub> (10)	—	—	—	75	—	—	75	$\mu$ s				
t <sub>LTD_Manual</sub> (11)	—	15	—	—	15	—	—	$\mu$ s				
t <sub>LTD_Manual</sub> (12)	—	—	—	4000	—	—	4000	ns				
t <sub>LTD_Auto</sub> (13)	—	—	—	4000	—	—	4000	ns				
Receiver CDR 3 dB Bandwidth in lock-to-data (LTD) mode	PCIe Gen1	2.0 - 3.5						MHz				
	PCIe Gen2	40 - 65						MHz				
	(OIF) CEI PHY at 6.375 Gbps	20 - 35						MHz				
	XAUI	10 - 18						MHz				
	SRIO 1.25 Gbps	10 - 18						MHz				
	SRIO 2.5 Gbps	10 - 18						MHz				
	SRIO 3.125 Gbps	6 - 10						MHz				
	GIGE	6 - 10						MHz				
	SONET OC12	3 - 6						MHz				
	SONET OC48	14 - 19						MHz				
Receiver buffer and CDR offset cancellation time (per channel)	—	—	—	17000	—	—	17000	recon fig_clk cycles				
Programmable DC gain	DC Gain Setting = 0	—	0	—	—	0	—	dB				
	DC Gain Setting = 1	—	3	—	—	3	—	dB				
	DC Gain Setting = 2	—	6	—	—	6	—	dB				

**Table 1–35. Transceiver Specifications for Arria II GZ Devices (Part 4 of 5)**

Symbol/ Description	Conditions	–C3 and –I3 (1)			–C4 and –I4			Unit		
		Min	Typ	Max	Min	Typ	Max			
<b>Transmitter</b>										
Supported I/O Standards		1.5-V PCML								
Data rate (14)	—	600	—	6375	600	—	3750	Mbps		
V <sub>OCM</sub>	0.65 V setting	—	650	—	—	650	—	mV		
Differential on-chip termination resistors	85-Ω setting	85 ± 15%			85 ± 15%			Ω		
	100-Ω setting	100 ± 15%			100 ± 15%			Ω		
	120-Ω setting	120 ± 15%			120 ± 15%			Ω		
	150-Ω setting	150 ± 15%			150 ± 15%			Ω		
Differential and common mode return loss	PCIe Gen1 and Gen2 (TX V <sub>OD</sub> =4), XAUI (TX V <sub>OD</sub> =6), HiGig+ (TX V <sub>OD</sub> =6), CEI SR/LR (TX V <sub>OD</sub> =8), SRIO SR (V <sub>OD</sub> =6), SRIO LR (V <sub>OD</sub> =8), CPRI LV (V <sub>OD</sub> =6), CPRI HV (V <sub>OD</sub> =2), OBSAI (V <sub>OD</sub> =6), SATA (V <sub>OD</sub> =4),	Compliant								
Rise time (15)	—	50	—	200	50	—	200	ps		
Fall time (15)	—	50	—	200	50	—	200	ps		
Intra-differential pair skew	—	—	—	15	—	—	15	ps		
Intra-transceiver block transmitter channel-to-channel skew	×4 PMA and PCS bonded mode Example: XAUI, PCIe ×4, Basic ×4	—	—	120	—	—	120	ps		
Inter-transceiver block transmitter channel-to-channel skew	×8 PMA and PCS bonded mode Example: PCIe ×8, Basic ×8	—	—	500	—	—	500	ps		
<b>CMU0 PLL and CMU1 PLL</b>										
Supported Data Range	—	600	—	6375	600	—	3750	Mbps		
p11_powerdown minimum pulse width (tp11_powerdown)	—	1			1			μs		
CMU PLL lock time from p11_powerdown de-assertion	—	—	—	100	—	—	100	μs		

**Table 1–39. Transmitter Pre-Emphasis Levels for Arria II GZ Devices (Part 2 of 2)**

Pre- Emphasis 1st Post-Tap Setting	V <sub>OD</sub> Setting							
	0	1	2	3	4	5	6	7
29	N/A	N/A	N/A	12.5	9.6	7.7	6.3	4.3
30	N/A	N/A	N/A	N/A	11.4	9	7.4	N/A
31	N/A	N/A	N/A	N/A	12.9	10	8.2	N/A

Table 1–40 lists the transceiver jitter specifications for all supported protocols for Arria II GX devices.

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (Note 1) (Part 1 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max										
<b>SONET/SDH Transmit Jitter Generation (2)</b>														
Peak-to-peak jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	—	—	0.1	—	—	0.1	UI
RMS jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	—	—	0.01	—	—	0.01	UI
Peak-to-peak jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	—	—	0.1	—	—	0.1	UI
RMS jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	—	—	0.01	—	—	0.01	UI
<b>SONET/SDH Receiver Jitter Tolerance (2)</b>														
Jitter tolerance at 622.08 Mbps	Jitter frequency = 0.03 KHz Pattern = PRBS15	> 15			> 15			> 15			> 15			UI
	Jitter frequency = 25 KHZ Pattern = PRBS15	> 1.5			> 1.5			> 1.5			> 1.5			UI
	Jitter frequency = 250 KHz Pattern = PRBS15	> 0.15			> 0.15			> 0.15			> 0.15			UI

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 9 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max										
<b>OBSAI Receiver Jitter Tolerance (12)</b>														
Deterministic jitter tolerance at 768 Mbps, 1536 Mbps, and 3072 Mbps	Pattern = CJPAT	> 0.37			> 0.37			> 0.37			> 0.37			UI
Combined deterministic and random jitter tolerance at 768 Mbps, 1536 Mbps, and 3072 Mbps	Pattern = CJPAT	> 0.55			> 0.55			> 0.55			> 0.55			UI
Sinusoidal jitter tolerance at 768 Mbps	Jitter frequency = 5.4 KHz Pattern = CJPAT	> 8.5			> 8.5			> 8.5			> 8.5			UI
	Jitter frequency = 460.8 KHz to 20 MHz Pattern = CJPAT	> 0.1			> 0.1			> 0.1			> 0.1			UI
Sinusoidal jitter tolerance at 1536 Mbps	Jitter frequency = 10.9 KHz Pattern = CJPAT	> 8.5			> 8.5			> 8.5			> 8.5			UI
	Jitter frequency = 921.6 KHz to 20 MHz Pattern = CJPAT	> 0.1			> 0.1			> 0.1			> 0.1			UI

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 10 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Sinusoidal jitter tolerance at 3072 Mbps	Jitter frequency = 21.8 KHz Pattern = CJPAT	> 8.5			> 8.5			> 8.5			> 8.5			UI
	Jitter frequency = 1843.2 KHz to 20 MHz Pattern = CJPAT	> 0.1			> 0.1			> 0.1			> 0.1			UI

**Notes to Table 1–40:**

- (1) Dedicated `refclk` pins are used to drive the input reference clocks. The jitter numbers are valid for the stated conditions only.
- (2) The jitter numbers for SONET/SDH are compliant to the GR-253-CORE Issue 3 Specification.
- (3) The jitter numbers for XAUI are compliant to the IEEE802.3ae-2002 Specification.
- (4) The jitter numbers for PCIe are compliant to the PCIe Base Specification 2.0.
- (5) The jitter numbers for SRIO are compliant to the RapidIO Specification 1.3.
- (6) The jitter numbers for GIGE are compliant to the IEEE802.3-2002 Specification.
- (7) The jitter numbers for HiGig are compliant to the IEEE802.3ae-2002 Specification.
- (8) The HD-SDI and 3G-SDI jitter numbers are compliant to the SMPTE292M and SMPTE424M Specifications.
- (9) Arria II PCIe receivers are compliant to this specification provided the `VTX_CM-DC-ACTIVEIDLE-DELTA` of the upstream transmitter is less than 50 mV.
- (10) The jitter numbers for Serial Advanced Technology Attachment (SATA) are compliant to the Serial ATA Revision 3.0 Specification.
- (11) The jitter numbers for Common Public Radio Interface (CPRI) are compliant to the CPRI Specification V3.0.
- (12) The jitter numbers for Open Base Station Architecture Initiative (OBSAI) are compliant to the OBSAI RP3 Specification V4.1.

Table 1–41 lists the transceiver jitter specifications for all supported protocols for Arria II GZ devices.

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (*Note 1*), (*2*) (Part 1 of 7)**

Symbol/ Description	Conditions	-C3 and -I3			-C4 and -I4			Unit
		Min	Typ	Max	Min	Typ	Max	
<b>SONET/SDH Transmit Jitter Generation (<i>3</i>)</b>								
Peak-to-peak jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	UI
RMS jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	UI
Peak-to-peak jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	UI
RMS jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	UI
<b>SONET/SDH Receiver Jitter Tolerance (<i>3</i>)</b>								
Jitter tolerance at 622.08 Mbps	Jitter frequency = 0.03 KHz Pattern = PRBS15	> 15			> 15			UI
	Jitter frequency = 25 KHz Pattern = PRBS15	> 1.5			> 1.5			UI
	Jitter frequency = 250 KHz Pattern = PRBS15	> 0.15			> 0.15			UI

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 3 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
Peak-to-peak jitter	Jitter frequency = 22.1 KHz		> 8.5			> 8.5		UI
Peak-to-peak jitter	Jitter frequency = 1.875 MHz		> 0.1			> 0.1		UI
Peak-to-peak jitter	Jitter frequency = 20 MHz		> 0.1			> 0.1		UI
<b>PCIe Transmit Jitter Generation (8)</b>								
Total jitter at 2.5 Gbps (Gen1)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	0.25	UI
Total jitter at 5 Gbps (Gen2)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	—	UI
<b>PCIe Receiver Jitter Tolerance (8)</b>								
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	> 0.6			> 0.6			UI
Total jitter at 5 Gbps (Gen2)	Compliance pattern	Not supported			Not supported			UI
<b>PCIe (Gen 1) Electrical Idle Detect Threshold</b>								
V <sub>RX-IDLE-DETDIFFp-p</sub> (9)	Compliance pattern	65	—	175	65	—	175	UI
<b>SRIO Transmit Jitter Generation (10)</b>								
Deterministic jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.17	—	—	0.17	UI
Total jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.35	—	—	0.35	UI
<b>SRIO Receiver Jitter Tolerance (10)</b>								
Deterministic jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.37			> 0.37			UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.55			> 0.55			UI
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 22.1 KHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 8.5			> 8.5			UI
	Jitter frequency = 1.875 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1			> 0.1			UI
	Jitter frequency = 20 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1			> 0.1			UI
<b>GIGE Transmit Jitter Generation (11)</b>								
Deterministic jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.14	—	—	0.14	UI
Total jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.279	—	—	0.279	UI

**Table 1–44. PLL Specifications for Arria II GX Devices (Part 3 of 3)**

<b>Symbol</b>	<b>Description</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$t_{CASC\_OUTJITTER\_PERIOD\_DEDCLK}$ <b>(6), (7)</b>	Period Jitter for dedicated clock output in cascaded PLLs ( $f_{OUT} \geq 100$ MHz)	—	—	425	ps (p-p)
	Period Jitter for dedicated clock output in cascaded PLLs ( $f_{OUT} \leq 100$ MHz)	—	—	42.5	mUI (p-p)

**Notes to Table 1–44:**

- (1)  $f_{IN}$  is limited by the I/O  $f_{MAX}$ .
- (2) The VCO frequency reported by the Quartus II software in the PLL summary section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the  $f_{VCO}$  specification.
- (3) A high-input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean-clock source, which is less than 200 ps.
- (4)  $F_{REF}$  is  $f_{IN}/N$  when  $N = 1$ .
- (5) This specification is limited by the lower of the two: I/O  $f_{MAX}$  or  $f_{OUT}$  of the PLL.
- (6) Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in [Table 1–62 on page 1–70](#).
- (7) The cascaded PLL specification is only applicable with the following condition:
  - a. Upstream PLL:  $0.59$  MHz  $\leq$  Upstream PLL BW  $< 1$  MHz
  - b. Downstream PLL: Downstream PLL BW  $> 2$  MHz

[Table 1–45](#) lists the PLL specifications for Arria II GZ devices when operating in both the commercial junction temperature range (0° to 85°C) and the industrial junction temperature range (-40° to 100°C).

**Table 1–45. PLL Specifications for Arria II GZ Devices (Part 1 of 2)**

<b>Symbol</b>	<b>Parameter</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$f_{IN}$	Input clock frequency (-3 speed grade)	5	—	717 (1)	MHz
	Input clock frequency (-4 speed grade)	5	—	717 (1)	MHz
$f_{INPFD}$	Input frequency to the PFD	5	—	325	MHz
$f_{VCO}$	PLL VCO operating range (-3 speed grade)	600	—	1,300	MHz
	PLL VCO operating range (-4 speed grade)	600	—	1,300	MHz
$t_{EINDUTY}$	Input clock or external feedback clock input duty cycle	40	—	60	%
$f_{OUT}$	Output frequency for internal global or regional clock (-3 speed grade)	—	—	700 (2)	MHz
	Output frequency for internal global or regional clock (-4 speed grade)	—	—	500 (2)	MHz
$f_{OUT\_EXT}$	Output frequency for external clock output (-3 speed grade)	—	—	717 (2)	MHz
	Output frequency for external clock output (-4 speed grade)	—	—	717 (2)	MHz
$t_{OUTDUTY}$	Duty cycle for external clock output (when set to 50%)	45	50	55	%
$t_{FCOMP}$	External feedback clock compensation time	—	—	10	ns
$t_{CONFIGPLL}$	Time required to reconfigure scan chain	—	3.5	—	scanclk cycles
$t_{CONFIGPHASE}$	Time required to reconfigure phase shift	—	1	—	scanclk cycles
$f_{SCANCLK}$	scanclk frequency	—	—	100	MHz
$t_{LOCK}$	Time required to lock from end-of-device configuration or de-assertion of areset	—	—	1	ms

**Table 1–45. PLL Specifications for Arria II GZ Devices (Part 2 of 2)**

<b>Symbol</b>	<b>Parameter</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$t_{DLOCK}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	1	ms
$f_{CLBW}$	PLL closed-loop low bandwidth	—	0.3	—	MHz
	PLL closed-loop medium bandwidth	—	1.5	—	MHz
	PLL closed-loop high bandwidth (7)	—	4	—	MHz
$t_{PLL\_PSERR}$	Accuracy of PLL phase shift	—	—	$\pm 50$	ps
$t_{ARESET}$	Minimum pulse width on the <code>areset</code> signal	10	—	—	ns
$t_{INCCJ} \text{ (3), (4)}$	Input clock cycle to cycle jitter ( $F_{REF} \geq 100$ MHz)	—	—	0.15	UI (p-p)
	Input clock cycle to cycle jitter ( $F_{REF} < 100$ MHz)	—	—	$\pm 750$	ps (p-p)
$t_{OUTPJ\_DC} \text{ (5)}$	Period Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Period Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTCCJ\_DC} \text{ (5)}$	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTPJ\_IO} \text{ (5), (8)}$	Period Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Period Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{OUTCCJ\_IO} \text{ (5), (8)}$	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{CASC\_OUTPJ\_DC} \text{ (5), (6)}$	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} \geq 100$ MHz)	—	—	250	ps (p-p)
	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} < 100$ MHz)	—	—	25	mUI (p-p)
$f_{DRIFT}$	Frequency drift after PFDENA is disabled for duration of 100 us	—	—	$\pm 10$	%

**Notes to Table 1–45:**

- (1) This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.
- (2) This specification is limited by the lower of the two: I/O  $F_{MAX}$  or  $F_{OUT}$  of the PLL.
- (3) A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source that is less than 120 ps.
- (4)  $F_{REF}$  is  $f_{IN/N}$  when  $N = 1$ .
- (5) Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in [Table 1–64 on page 1–71](#).
- (6) The cascaded PLL specification is only applicable with the following condition:
  - a. Upstream PLL:  $0.59$  MHz  $\leq$  Upstream PLL BW  $< 1$  MHz
  - b. Downstream PLL: Downstream PLL BW  $> 2$  MHz
- (7) High bandwidth PLL settings are not supported in external feedback mode.
- (8) External memory interface clock output jitter specifications use a different measurement method, which is available in [Table 1–63 on page 1–71](#).

## Periphery Performance

This section describes periphery performance, including high-speed I/O, external memory interface, and IOE programmable delay.

I/O performance supports several system interfaces, for example the high-speed I/O interface, external memory interface, and the PCI/PCI-X bus interface. I/O using SSTL-18 Class I termination standard can achieve up to the stated DDR2 SDRAM interfacing speed with typical DDR2 SDRAM memory interface setup. I/O using general purpose I/O (GPIO) standards such as 3.0, 2.5, 1.8, or 1.5 LVTT/LVCMOS are capable of typical 200 MHz interfacing frequency with 10pF load.



Actual achievable frequency depends on design- and system-specific factors. You should perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

### High-Speed I/O Specification

Table 1–53 lists the high-speed I/O timing for Arria II GX devices.

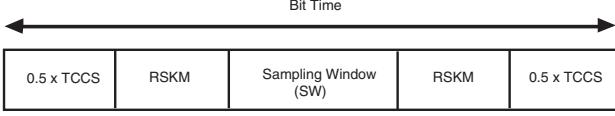
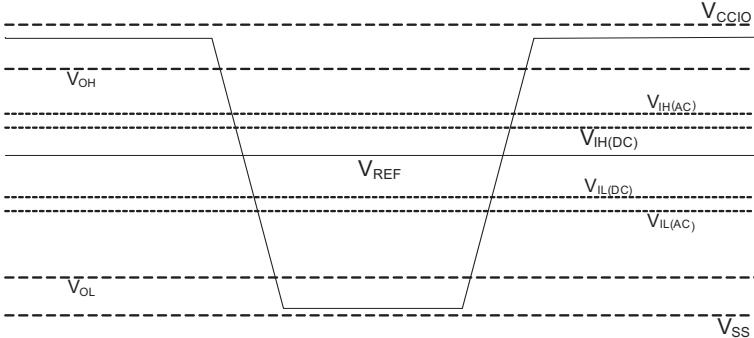
**Table 1–53. High-Speed I/O Specifications for Arria II GX Devices (Part 1 of 4)**

Symbol	Conditions	I3		C4		C5,I5		C6		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
<b>Clock</b>										
$f_{HSCLK\_IN}$ (input clock frequency)—Row I/O	Clock boost factor, W = 1 to 40 (1)	5	670	5	670	5	622	5	500	MHz
$f_{HSCLK\_IN}$ (input clock frequency)—Column I/O	Clock boost factor, W = 1 to 40 (1)	5	500	5	500	5	472.5	5	472.5	MHz
$f_{HSCLK\_OUT}$ (output clock frequency)—Row I/O	—	5	670	5	670	5	622	5	500	MHz
$f_{HSCLK\_OUT}$ (output clock frequency)—Column I/O	—	5	500	5	500	5	472.5	5	472.5	MHz

**Table 1–54. High-Speed I/O Specifications for Arria II GZ Devices (Note 1), (2), (10) (Part 2 of 3)**

<b>Symbol</b>	<b>Conditions</b>	<b>C3, I3</b>			<b>C4, I4</b>			<b>Unit</b>
		<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	
$f_{HSCLK\_OUT}$ (output clock frequency)	—	5	—	717 (7)	5	—	717 (7)	MHz
<b>Transmitter</b>								
$f_{HSDR}$ (true LVDS output data rate)	SERDES factor, J = 3 to 10 (using dedicated SERDES) (8)	(4)	—	1250	(4)	—	1250	Mbps
	SERDES factor J = 2, (using DDR registers)	(4)	—	(5)	(4)	—	(5)	Mbps
	SERDES factor J = 1, (uses an SDR register)	(4)	—	(5)	(4)	—	(5)	Mbps
$f_{HSDR}$ (emulated LVDS_E_3R output data rate) (5)	SERDES factor J = 4 to 10	(4)	—	1152	(4)	—	800	Mbps
$f_{HSDR}$ (emulated LVDS_E_1R output data rate)		(4)	—	200	(4)	—	200	Mbps
$t_{x\ Jitter}$	Total jitter for data rate, 600 Mbps to 1.6 Gbps	—	—	160	—	—	160	ps
	Total jitter for data rate, < 600 Mbps	—	—	0.1	—	—	0.1	UI
$t_{x\ Jitter}$ – emulated differential I/O standards with three external output resistor network	Total jitter for data rate, 600 Mbps to 1.25 Gbps	—	—	300	—	—	325	ps
	Total jitter for data rate < 600 Mbps	—	—	0.2	—	—	0.25	UI
$t_{x\ Jitter}$ – emulated differential I/O standards with one external output resistor network	—	—	—	0.15	—	—	0.15	UI
$t_{DUTY}$	TX output clock duty cycle for both True and emulated differential I/O standards	45	50	55	45	50	55	%

**Table 1-68. Glossary (Part 3 of 4)**

Letter	Subject	Definitions
	<b>SW (sampling window)</b>	The period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position within the sampling window: <i>Timing Diagram</i> 
S	Single-ended Voltage Referenced I/O Standard	The JEDEC standard for SSTL and HSTL I/O standards define both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state. The new logic state is then maintained as long as the input stays beyond the AC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing: <i>Single-Ended Voltage Referenced I/O Standard</i> 
T	<b>t<sub>C</sub></b>	High-speed receiver and transmitter input and output clock period.
	<b>TCCS (channel-to-channel-skew)</b>	The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the <i>Timing Diagram</i> figure under S in this table).
	<b>t<sub>DUTY</sub></b>	High-speed I/O block: Duty cycle on the high-speed transmitter output clock. <b>Timing Unit Interval (TUI)</b> The timing budget allowed for skew, propagation delays, and data sampling window. ( $TUI = 1 / (\text{Receiver Input Clock Frequency Multiplication Factor}) = t_c/w$ )
	<b>t<sub>FALL</sub></b>	Signal high-to-low transition time (80-20%)
	<b>t<sub>INCCJ</sub></b>	Cycle-to-cycle jitter tolerance on the PLL clock input.
	<b>t<sub>OUTPJ_IO</sub></b>	Period jitter on the general purpose I/O driven by a PLL.
	<b>t<sub>OUTPJ_DC</sub></b>	Period jitter on the dedicated clock output driven by a PLL.
	<b>t<sub>RISE</sub></b>	Signal low-to-high transition time (20-80%).

**Table 1–68. Glossary (Part 4 of 4)**

<b>Letter</b>	<b>Subject</b>	<b>Definitions</b>
<b>U, V</b>	$V_{CM(DC)}$	DC common mode input voltage.
	$V_{ICM}$	Input common mode voltage: The common mode of the differential signal at the receiver.
	$V_{ID}$	Input differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.
	$V_{DIF(AC)}$	AC differential input voltage: Minimum AC input differential voltage required for switching.
	$V_{DIF(DC)}$	DC differential input voltage: Minimum DC input differential voltage required for switching.
	$V_{IH}$	Voltage input high: The minimum positive voltage applied to the input which is accepted by the device as a logic high.
	$V_{IH(AC)}$	High-level AC input voltage.
	$V_{IH(DC)}$	High-level DC input voltage.
	$V_{IL}$	Voltage input low: The maximum positive voltage applied to the input which is accepted by the device as a logic low.
	$V_{IL(AC)}$	Low-level AC input voltage.
	$V_{IL(DC)}$	Low-level DC input voltage.
	$V_{OCM}$	Output common mode voltage: The common mode of the differential signal at the transmitter.
	$V_{OD}$	Output differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter.
<b>W, X, Y, Z</b>	<b>W</b>	High-speed I/O block: The clock boost factor.

## Document Revision History

Table 1–69 lists the revision history for this chapter.

**Table 1–69. Document Revision History (Part 1 of 2)**

<b>Date</b>	<b>Version</b>	<b>Changes</b>
December 2013	4.4	Updated Table 1–34 and Table 1–35.
July 2012	4.3	<ul style="list-style-type: none"> <li>■ Updated the <math>V_{CCH\_GXBL/R}</math> operating conditions in Table 1–6.</li> <li>■ Finalized Arria II GZ information in Table 1–20.</li> <li>■ Added BLVDS specification in Table 1–32 and Table 1–33.</li> <li>■ Updated input and output waveforms in Table 1–68.</li> </ul>
December 2011	4.2	<ul style="list-style-type: none"> <li>■ Updated Table 1–32, Table 1–33, Table 1–34, Table 1–35, Table 1–40, Table 1–41, Table 1–54, and Table 1–67.</li> <li>■ Minor text edits.</li> </ul>
June 2011	4.1	<ul style="list-style-type: none"> <li>■ Added Table 1–60.</li> <li>■ Updated Table 1–32, Table 1–33, Table 1–38, Table 1–41, and Table 1–61.</li> <li>■ Updated the “Switching Characteristics” section introduction.</li> <li>■ Minor text edits.</li> </ul>